QP Code: RD17001029	Reg. No											AR 17
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## GIET MAIN CAMPUS AUTONOMOUS GUNUPUR – 765022

SMINOR		B. Tech Deg	,	enth Semester)
90		BMEPE7023	`	lern Manufacturing Processes
	3440	(	Mecha	nical Engineering)
T	ime: 2 h	ırs		Maximum: 50 Marks
		The figures in the right	t hand r	margin indicate marks.
P	ART – A	A: (Multiple Choice Questions)		$(1 \times 10 = 10 \text{ Marks})$
Q.1.	Answe	r ALL questions		
a.	In ECN	<i>A</i> , the material removal is due to		
	(i)	Erosion	(ii)	Corrosion
	(iii)	Ion displacement	(iv)	Fusion
b.	In abra	asive jet machining, as the distance	betwee	enthe nozzle tip and work surface increases the
	materia	alremoval rate		
	(i)	Stereolithography Apparatus	(ii)	Five axis CNC Milling
	(iii)	Selective laser sintering (SLS)	(iv)	Multi-jet modelling
c.	Which	of the following gas, should never b	e used a	as the carrier of abrasives?
	(i)	Nitrogen	(ii)	CO
	(iii)	Oxygen	(iv)	Air
d.	In elec	trodischarge machining (EDM), if	the ther	rmalconductivity of tool is high and the specifc
	heat of	fwork piece is low, then the tool v	wear rat	te and materialremoval rate are expected to be
	respect	rively		
	(i)	High and high	(ii)	Low and low
	(iii)	High and low	(iv)	Low and high
e.				ocesses are available in a shop floor. The most
				on of 6 mm $\times$ 6 mm and 25 mm deep is
	(i)	Abrasive jet machining	(ii)	Plasma arc machining
	(iii)	Laser beam machining	(iv)	Electro discharge machining
f.	_	ocess utilizing mainly thermal energ	-	-
		Ultrasonic machining		_
	(iii)	Abrasive jet machining	(iv)	Laser beam machining
g.		n-traditional machining process that		· ·
	(i)	electron beam machining	(ii)	electro chemical machining
	(iii)	electro chemical discharge	(iv)	electro discharge machining
		machining		
h.				material removal rate (MRR) is plotted as a
		on of the feed force of the USM tool.		creasing feed
		the MRR exhibits the following beha		5 11 1
	(i)	Increases linearly	(ii)	Decreases linearly
	(iii)	Does not change	(iv)	First increases and then decreases
i.		•	conditi	onsthat have to be met for making a successful
	cut are	IIIAL		

wire and sample are electrically (ii) wire and sample are electrically conducting (i) non-conducting

(iii) wire is electrically conducting (iv) sample is electrically conducting and wire and sample iselectrically non-conducting conducting

j. Name the source from below which is NOT used for PVD:

(i)Combustion flame heating
(ii)Electron beam heating
(iii)Resistance boat heating
(iv)Arc source evaporation

PART – B: (Short Answer Questions)

(2 x 5 = 10 Marks)

## Q.2. Answer ALL questions

- a. What factors should be considered in selecting the tool materials in ECM?
- b. Describe the factors that should be considered in selecting the abrasive in AWJM
- c. Give the applications of electron beam machining
- d. Classify the types of laser used in LBM process.
- e. Differentiate between conventional grinding and ECG.

## **PART – C: (Long Answer Questions)**

 $(6 \times 5 = 30 \text{ Marks})$ 

## Answer ANY FIVE questions Marks 8 3. Explain the working principle, application and advantages of WJM 4. During machining of ceramics, a MRR of 8 mm<sup>3</sup>/min is achieved by Al<sub>2</sub>O<sub>3</sub> 7 abrasive grits having a gritdiameter of 80 µm. If 120 µm grits were used, what would be the MRR? For the same problem, the feed force is increased by 50% along with a reduction in concentration by 70%. What would be the effect on MRR. 8 5. Differentiate between sinker EDM and wire EDM. 6. If in a RC type generator, to get an idle time of 500 µs for open circuit voltage 7 of 100 V and maximum charging voltage of 70 V, determine charging resistance. Assume $C = 100 \mu F$ .

7. With a neat sketch explain the working principle of LBM.

8

7

- 8. Explain the working principle, application and advantages of PAM.
- 9. Explain different types of Physical vapour deposition method with neat sketch.
- 8
- 10. Explain about reverse engineering and mention its advantages, disadvantages and applications.

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